

## N & P-Channel 150-V (D-S) MOSFET

### Key Features:

- Low  $r_{DS(on)}$  trench technology
- Low thermal impedance
- Fast switching speed

### Typical Applications:

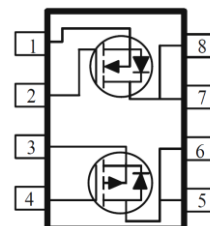
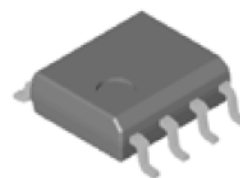
- White LED boost converters
- Automotive Systems
- Industrial DC/DC Conversion Circuits

PRODUCT SUMMARY		
$V_{DS}$ (V)	$r_{DS(on)}$ (m $\Omega$ )	$I_D$ (A)
150	255 @ $V_{GS} = 10V$	2.3
	290 @ $V_{GS} = 4.5V$	2.2
-150	500 @ $V_{GS} = -10V$	-1.7
	530 @ $V_{GS} = -4.5V$	-1.6



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

SO-8



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Nch Limit	Pch Limit	Units	
Drain-Source Voltage	$V_{DS}$	150	-150	V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$		
Continuous Drain Current <sup>a</sup>	$I_D$	$T_A = 25^\circ\text{C}$	2.3	-1.7	A
		$T_A = 70^\circ\text{C}$	1.8	-1.3	
Pulsed Drain Current <sup>b</sup>	$I_{DM}$	9	-7		
Continuous Source Current (Diode Conduction) <sup>a</sup>	$I_S$	2.5	-2.3	A	
Power Dissipation <sup>a</sup>	$P_D$	$T_A = 25^\circ\text{C}$	2.1	2.1	W
		$T_A = 70^\circ\text{C}$	1.3	1.3	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 150		$^\circ\text{C}$	

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Ambient <sup>a</sup>	$R_{\theta JA}$	$t \leq 10$ sec	62.5
		Steady State	110

### Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

## Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$ <b>(Nch)</b>	1			V
		$V_{DS} = V_{GS}, I_D = -250 \mu A$ <b>(Pch)</b>	-1			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120 V, V_{GS} = 0 V$ <b>(Nch)</b>			1	$\mu A$
		$V_{DS} = -120 V, V_{GS} = 0 V$ <b>(Pch)</b>			-1	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = 5 V, V_{GS} = 10 V$ <b>(Nch)</b>	3.5			A
		$V_{DS} = -5 V, V_{GS} = -10 V$ <b>(Pch)</b>	-2.5			A
Drain-Source On-Resistance <sup>a</sup>	$r_{DS(on)}$	$V_{GS} = 10 V, I_D = 2.1 A$ <b>(Nch)</b>			255	m $\Omega$
		$V_{GS} = 4.5 V, I_D = 1.7 A$ <b>(Nch)</b>			290	
		$V_{GS} = -10 V, I_D = -1.4 A$ <b>(Pch)</b>			500	m $\Omega$
		$V_{GS} = -4.5 V, I_D = -1 A$ <b>(Pch)</b>			530	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 15 V, I_D = 2.1 A$ <b>(Nch)</b>		11		S
		$V_{DS} = -15 V, I_D = -1.4 A$ <b>(Pch)</b>		11		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 1.3 A, V_{GS} = 0 V$ <b>(Nch)</b>		0.76		V
		$I_S = 1.2 A, V_{GS} = 0 V$ <b>(Pch)</b>		0.75		V
<b>Dynamic <sup>b</sup></b>						
Total Gate Charge	$Q_g$	N - Channel $V_{DS} = 75 V, V_{GS} = 4.5 V, I_D = 2.1 A$		10		nC
Gate-Source Charge	$Q_{gs}$		4.0			
Gate-Drain Charge	$Q_{gd}$		4.7			
Total Gate Charge	$Q_g$	P - Channel $V_{DS} = -75 V, V_{GS} = -4.5 V,$ $I_D = -1.4 A$		6		nC
Gate-Source Charge	$Q_{gs}$		2.0			
Gate-Drain Charge	$Q_{gd}$		2.9			
Turn-On Delay Time	$t_{d(on)}$	N - Channel $V_{DD} = 75 V, R_L = 35.7 \Omega, I_D = 2.1$ $A, V_{GEN} = 10 V, R_{GEN} = 6 \Omega$		7		ns
Rise Time	$t_r$		7			
Turn-Off Delay Time	$t_{d(off)}$		47			
Fall Time	$t_f$		20			
Turn-On Delay Time	$t_{d(on)}$	P - Channel $V_{DD} = -75 V, R_L = 53.6 \Omega,$ $I_D = -1.4 A,$ $V_{GEN} = -10 V, R_{GEN} = 6 \Omega$		8		ns
Rise Time	$t_r$		7			
Turn-Off Delay Time	$t_{d(off)}$		96			
Fall Time	$t_f$		79			
Input Capacitance	$C_{iss}$	N - Channel $V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz$		1016		pF
Output Capacitance	$C_{oss}$		83			
Reverse Transfer Capacitance	$C_{rss}$		40			
Input Capacitance	$C_{iss}$	P - Channel $V_{DS} = -15 V, V_{GS} = 0 V, f = 1 MHz$		1008		pF
Output Capacitance	$C_{oss}$		100			
Reverse Transfer Capacitance	$C_{rss}$		61			